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Stocking Distributor

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Vishay/Siliconix
SMMA511DJ-T1-GE3

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New Product

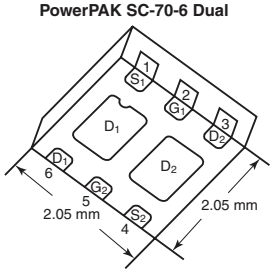
SMMA511DJ

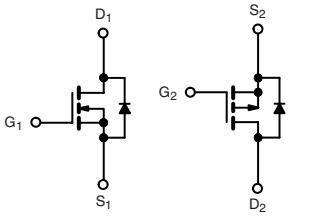
Vishay Siliconix

N- and P-Channel 12 V (D-S) MOSFET

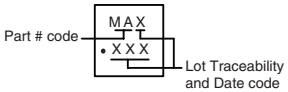
PRODUCT SUMMARY		
	N-CHANNEL	P-CHANNEL
V_{DS} (V)	12	- 12
$R_{DS(on)}$ (Ω) at V_{GS} = ± 4.5 V	0.040	0.070
$R_{DS(on)}$ (Ω) at V_{GS} = ± 2.5 V	0.048	0.100
$R_{DS(on)}$ (Ω) at V_{GS} = ± 1.8 V	0.063	0.140
I_D (A)[a]	4.5	- 4.5
Configuration	N- and P-Pair	

PowerPAK SC-70-6 Dual





Marking Code



FEATURES

- High Quality Manufacturing Process Using SMM Process Flow
- **Halogen-free According to IEC 61249-2-21 Definition**
- TrenchFET® Power MOSFETs
- New Thermally Enhanced PowerPAK® SC-70 Package
  - Small Footprint Area
  - Low On-Resistance
- Compliant to RoHS Directive 2002/95/EC
- Find out more about Vishay's Medical Products at: www.vishay.com/medical-mosfets

Pb-free
RoHS COMPLIANT
HALOGEN FREE

APPLICATION EXAMPLES

- Medical Implantable Applications Including
  - Drug Delivery Systems
  - Defibrillators
  - Pacemakers
  - Hearing Aids
  - Other Implantable Devices
- Load Switch for Portable Devices

ORDERING INFORMATION	
Package	PowerPAK SC-70
Lead (Pb)-free and Halogen-free	SMMA511DJ-T1-GE3

ABSOLUTE MAXIMUM RATINGS T_A = 25 °C, unless otherwise noted

PARAMETER		SYMBOL	N-CHANNEL	P-CHANNEL	UNIT
Drain-Source Voltage		V_{DS}	12	- 12	V
Gate-Source Voltage		V_{GS}	± 8	± 8	
Continuous Drain Current (T_J = 150 °C)	T_C = 25 °C[a]	I_D	4.5	- 4.5	A
	T_C = 70 °C[a]		4.5	- 4.5	
	T_A = 25 °C[a, b, c]		4.5	- 4.3	
	T_A = 70 °C[a, b, c]		4.5	- 3.4	
Pulsed Drain Current		I_{DM}	20	- 10	
Continuous Source-Drain Diode Current	T_C = 25 °C [a]	I_S	4.5	- 4.5	
	T_A = 25 °C[b, c]		1.6	- 1.6	
Maximum Power Dissipation	T_C = 25 °C	P_D	6.5	6.5	W
	T_C = 70 °C		5	5	
	T_A = 25 °C[a, c]		1.9	1.9	
	T_A = 70 °C[a, c]		1.2	1.2	
Operating Junction and Storage Temperature Range		T_J, T_{stg}	- 55 to + 150		°C
Soldering Recommendations (Peak Temperature)[d, e]			260		

New Product

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THERMAL RESISTANCE RATINGS

PARAMETER		SYMBOL	N-CHANNEL TYP.	N-CHANNEL MAX.	P-CHANNEL TYP.	P-CHANNEL MAX.	UNIT
Maximum Junction-to-Ambient[b, f]	t ≤ 5 s	R_{thJA}	52	65	52	65	°C/W
Maximum Junction-to-Case (Drain)	Steady State	R_{thJC}	12.5	16	12.5	16	

Notes
a. Surface mounted on 1" x 1" FR4 board.
b. Package limit is ± 4.5 A.
c. t = 5 s.
d. See Solder Profile (*www.vishay.com/ppg?73257*). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.
f. Maximum under steady state conditions is 110 °C/W.

SPECIFICATIONS T_J = 25 °C, unless otherwise noted

PARAMETER	SYMBOL	TEST CONDITIONS			MIN.	TYP.	MAX.	UNIT
Static								
Drain-Source Breakdown Voltage	V_{DS}	V_{GS} = 0 V, I_D = 250 µA		N-Ch	12	-	-	V
		V_{GS} = 0 V, I_D = - 250 µA		P-Ch	- 12	-	-	
V_{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	I_D = 250 µA		N-Ch	-	12	-	mV/°C
		I_D = - 250 µA		P-Ch	-	- 7	-	
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I_D = 250 µA		N-Ch	-	- 2.8	-	
		I_D = - 250 µA		P-Ch	-	2.1	-	
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250 µA		N-Ch	0.4	-	1	V
		V_{DS} = V_{GS}, I_D = - 250 µA		P-Ch	- 0.4	-	- 1	
Gate-Body Leakage	I_{GSS}	V_{DS} = 0 V, V_{GS} = ± 8 V		N-Ch	-	-	± 100	nA
				P-Ch	-	-	± 100	
Zero Gate Voltage Drain Current	I_{DSS}	V_{GS} = 0 V	V_{DS} = 12 V	N-Ch	-	-	1	µA
		V_{GS} = 0 V	V_{DS} = - 12 V	P-Ch	-	-	- 1	
		V_{GS} = 0 V	V_{DS} = 12 V, T_J = 55 °C	N-Ch	-	-	10	
		V_{GS} = 0 V	V_{DS} = - 12 V, T_J = 55 °C	P-Ch	-	-	- 10	
On-State Drain Current[a]	$I_{D(on)}$	V_{GS} = 4.5 V	V_{DS} ≥ 5 V	N-Ch	15	-	-	A
		V_{GS} = - 4.5 V	V_{DS} ≤ - 5 V	P-Ch	- 8	-	-	
Drain-Source On-State Resistance[a]	$R_{DS(on)}$	V_{GS} = 4.5 V	I_D = 4.2 A	N-Ch	-	0.033	0.040	Ω
		V_{GS} = - 4.5 V	I_D = - 3.3 A	P-Ch	-	0.058	0.070	
		V_{GS} = 2.5 V	I_D = 3.8 A	N-Ch	-	0.039	0.048	
		V_{GS} = - 2.5 V	I_D = - 2.8 A	P-Ch	-	0.082	0.100	
		V_{GS} = 1.8 V	I_D = 1.6 A	N-Ch	-	0.051	0.063	
		V_{GS} = - 1.8 V	I_D = - 0.7 A	P-Ch	-	0.111	0.140	
Forward Transconductance[a]	g_{fs}	V_{DS} = 10 V, I_D = 4.2 A		N-Ch	-	13	-	S
		V_{DS} = - 10 V, I_D = - 3.3 A		P-Ch	-	9	-	
Dynamic[b]								
Input Capacitance	C_{iss}	V_{GS} = 0 V	N-Channel V_{DS} = 6 V, f = 1 MHz P-Channel V_{DS} = - 6 V, f = 1 MHz	N-Ch	-	400	-	pF
				P-Ch	-	400	-	
Output Capacitance	C_{oss}			N-Ch	-	120	-	
				P-Ch	-	140	-	
Reverse Transfer Capacitance	C_{rss}			N-Ch	-	70	-	
				P-Ch	-	100	-	

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SPECIFICATIONS T_J = 25 °C, unless otherwise noted								
PARAMETER	SYMBOL	TEST CONDITIONS			MIN.	TYP.	MAX.	UNIT
Dynamic[b]								
Total Gate Charge	Q_g	V_{GS} = 8 V	V_{DS} = 6 V, I_D = 5.5 A	N-Ch	-	7.5	12	nC
		V_{GS} = - 8 V	V_{DS} = - 6 V, I_D = - 4.3 A	P-Ch	-	8	12	
		V_{GS} = 4.5 V	N-Channel V_{DS} = 6 V, I_D = 5.5 A P-Channel V_{DS} = - 6 V, I_D = - 4.3 A	N-Ch	-	4.5	6.8	
		V_{GS} = - 4.5 V		P-Ch	-	5	7.5	
Gate-Source Charge	Q_{gs}	V_{GS} = 4.5 V		N-Ch	-	0.6	-	
		V_{GS} = - 4.5 V		P-Ch	-	0.8	-	
Gate-Drain Charge	Q_{gd}	V_{GS} = 4.5 V		N-Ch	-	0.8	-	
		V_{GS} = - 4.5 V		P-Ch	-	1.4	-	
Gate Resistance	R_g	f = 1 MHz		N-Ch	-	2.5	-	Ω
				P-Ch	-	7	-	
Turn-On Delay Time	$t_{d(on)}$	N-Channel V_{DD} = 6 V, R_L = 1.4 Ω, $I_D \cong$ 4.4 A, V_{GEN} = 4.5 V, R_g = 1 Ω P-Channel V_{DD} = - 6 V, R_L = 1.8 Ω, $I_D \cong$ - 3.4 A, V_{GEN} = - 4.5 V, R_g = 1 Ω		N-Ch	-	5	10	ns
				P-Ch	-	15	25	
Rise Time	t_r			N-Ch	-	15	25	
				P-Ch	-	25	40	
Turn-Off Delay Time	$t_{d(off)}$			N-Ch	-	35	55	
				P-Ch	-	20	30	
Fall Time	t_f			N-Ch	-	15	25	
				P-Ch	-	10	15	
Turn-On Delay Time	$t_{d(on)}$	N-Channel V_{DD} = 6 V, R_L = 1.4 Ω, $I_D \cong$ 4.4 A, V_{GEN} = 10 V, R_g = 1 Ω P-Channel V_{DD} = - 6 V, R_L = 1.8 Ω, $I_D \cong$ - 3.4 A, V_{GEN} = - 10 V, R_g = 1 Ω		N-Ch	-	5	10	
				P-Ch	-	5	10	
Rise Time	t_r			N-Ch	-	10	15	
				P-Ch	-	12	20	
Turn-Off Delay Time	$t_{d(off)}$			N-Ch	-	15	25	
				P-Ch	-	20	30	
Fall Time	t_f			N-Ch	-	10	15	
				P-Ch	-	10	15	
Source-Drain Body Diode Characteristics								
Continuous Source-Drain Diode Current	I_S	T_C = 25 °C		N-Ch	-	-	4.5	A
				P-Ch	-	-	- 4.5	
Pulse Diode Forward Current	I_{SM}			N-Ch	-	-	20	
				P-Ch	-	-	- 10	
Body Diode Voltage	V_{SD}	V_{GS} = 0 V	I_S = 4.4 A	N-Ch	-	0.8	1.2	V
			I_S = - 3.4 A	P-Ch	-	- 0.8	- 1.2	
Body Diode Reverse Recovery Time	t_{rr}	N-Channel I_F = 4.4 A, dI/dt = 100 A/µs, T_J = 25 °C P-Channel I_F = - 3.4 A, dI/dt = - 100 A/µs, T_J = 25 °C		N-Ch	-	15	30	ns
				P-Ch	-	30	60	
Body Diode Reverse Recovery Charge	Q_{rr}			N-Ch	-	8	20	nC
				P-Ch	-	12	24	
Reverse Recovery Fall Time	t_a			N-Ch	-	8.5	-	ns
				P-Ch	-	14	-	
Reverse Recovery Rise Time	t_b			N-Ch	-	8.5	-	
				P-Ch	-	16	-	

Notes

a. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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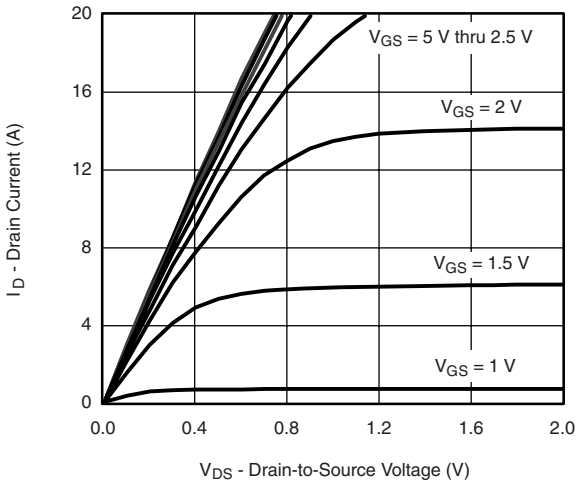
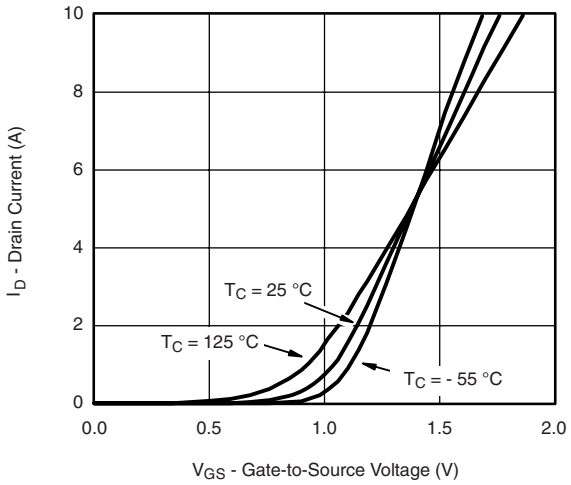
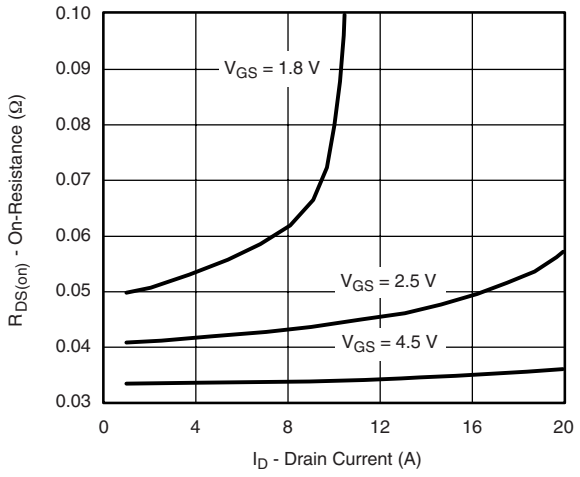
N-CHANNEL TYPICAL CHARACTERISTICS T_A = 25 °C, unless otherwise noted



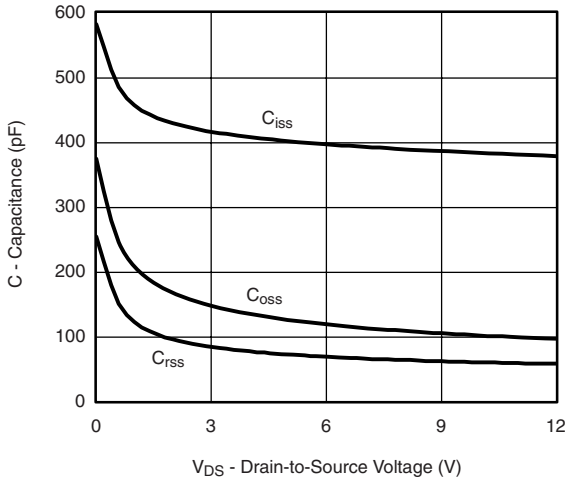
Output Characteristics



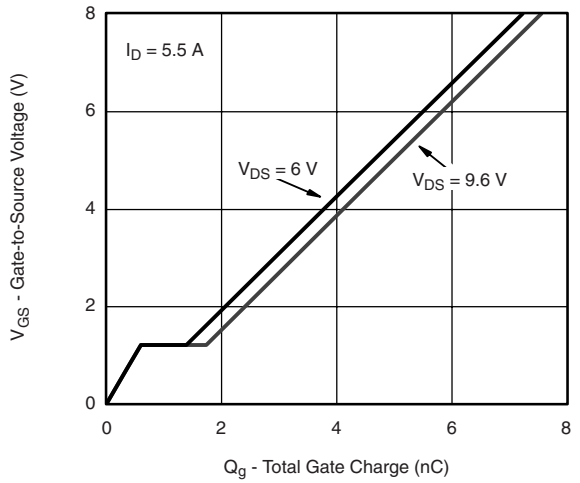
Transfer Characteristics



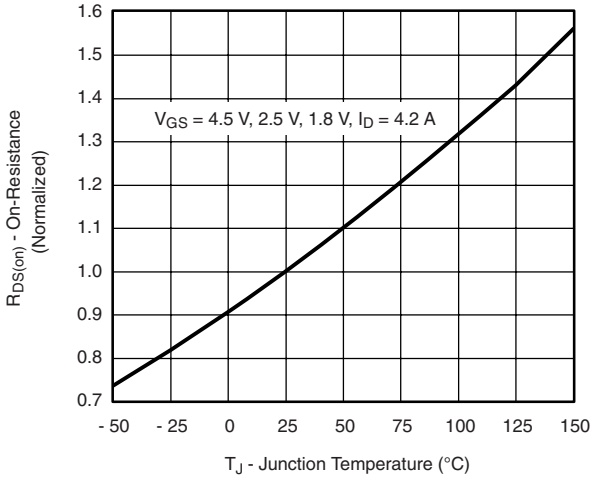
On-Resistance vs. Drain Current and Gate Voltage



Capacitance



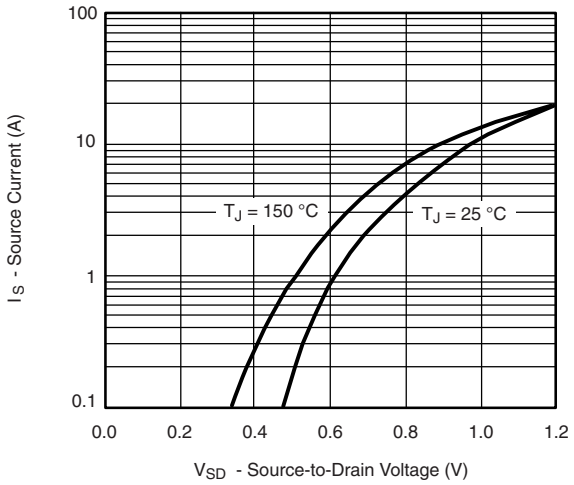
Gate Charge



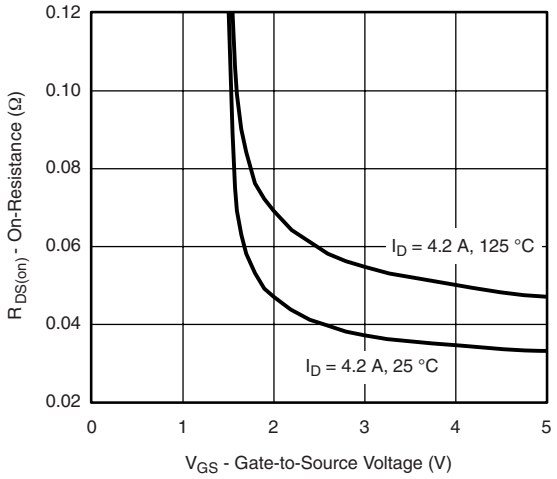
On-Resistance vs. Junction Temperature

New Product

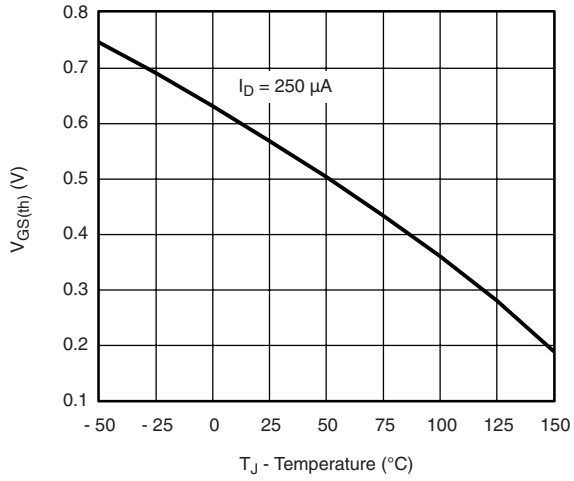
N-CHANNEL TYPICAL CHARACTERISTICS T_A = 25 °C, unless otherwise noted



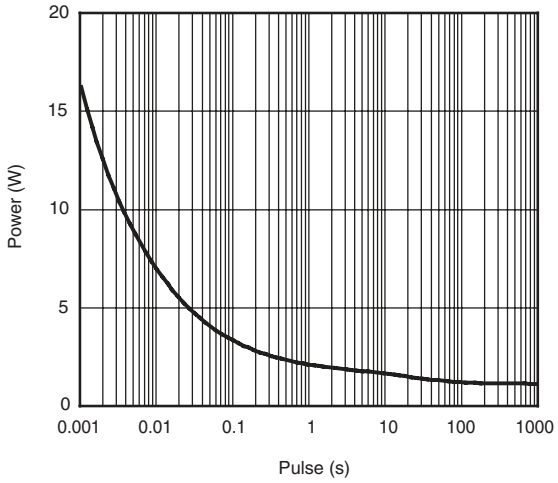
Soure-Drain Diode Forward Voltage



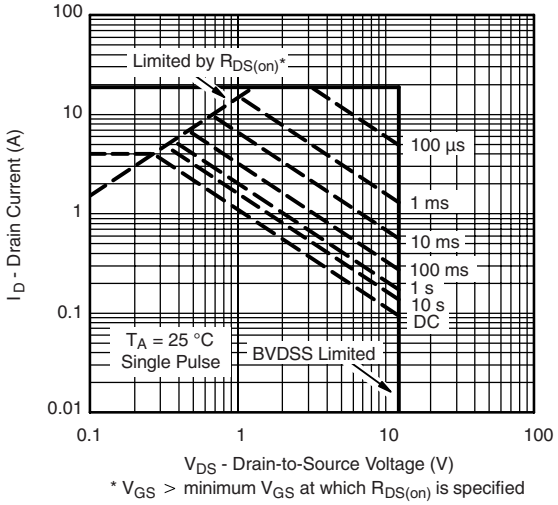
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient



* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Ambient

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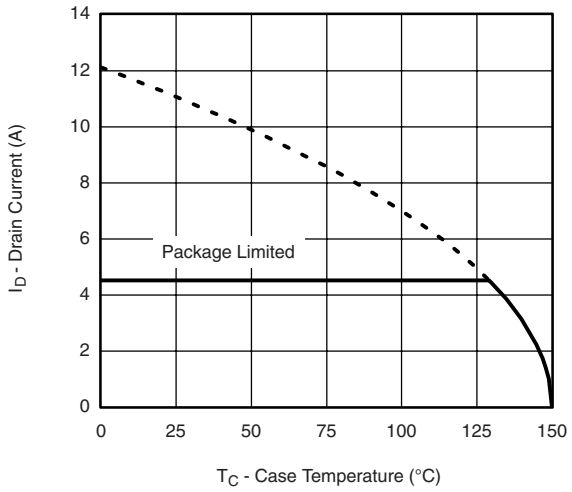
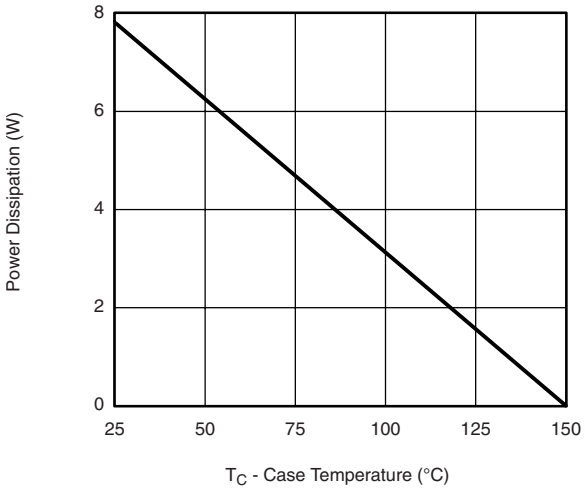
N-CHANNEL TYPICAL CHARACTERISTICS T_A = 25 °C, unless otherwise noted



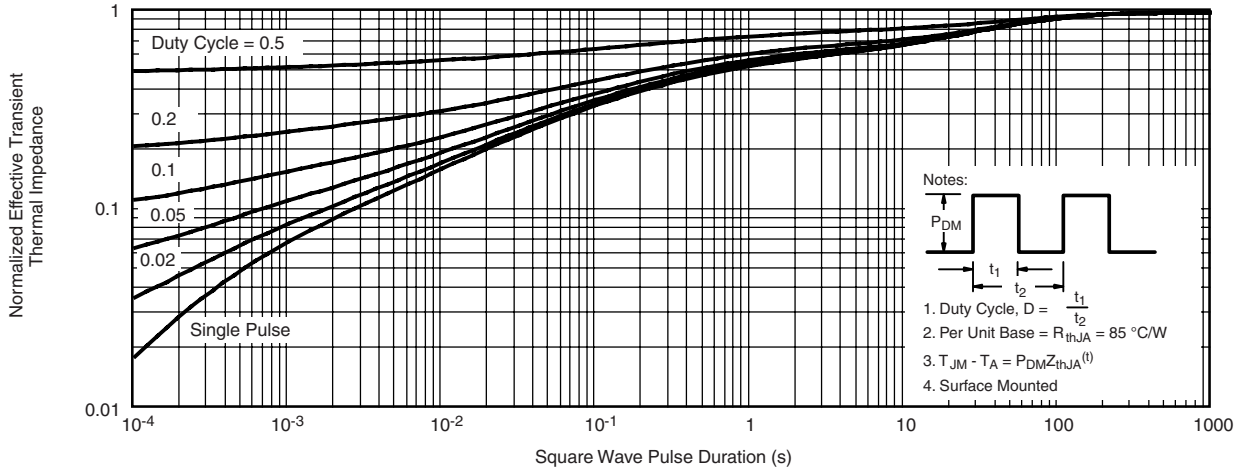
Current Derating*



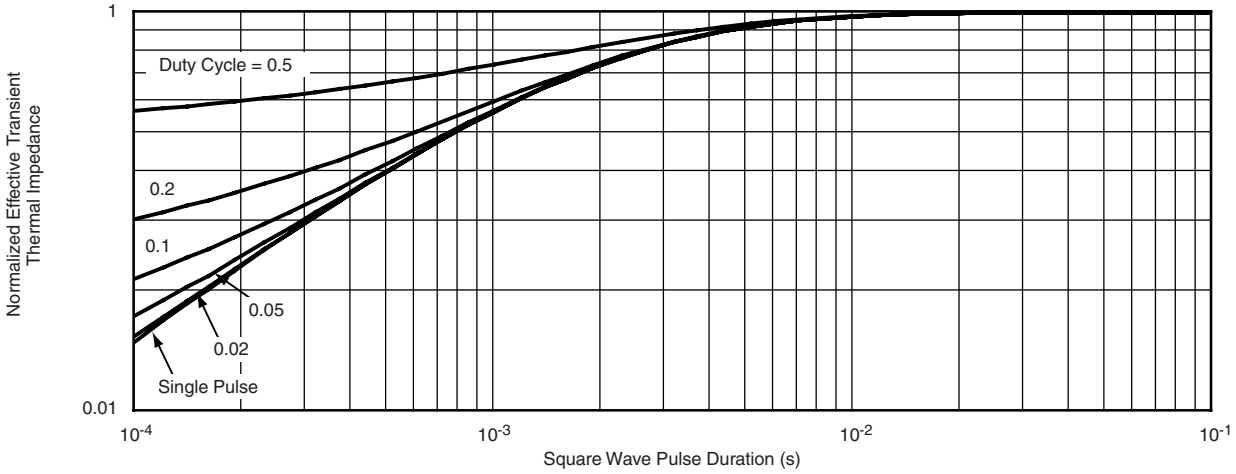
Power Derating

* The power dissipation P_D is based on $T_{J(max.)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

N-CHANNEL TYPICAL CHARACTERISTICS T_A = 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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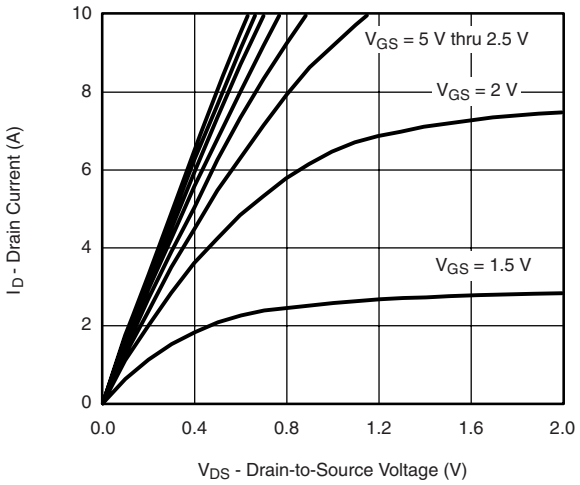
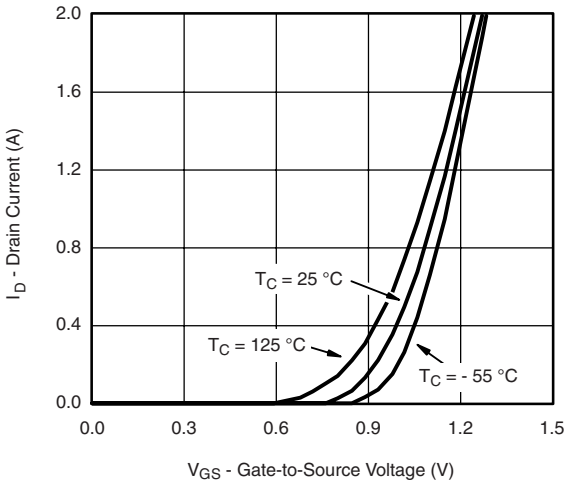
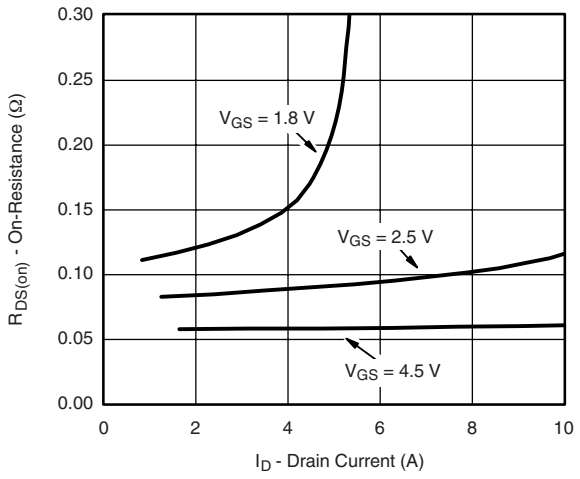
P-CHANNEL TYPICAL CHARACTERISTICS T_A = 25 °C, unless otherwise noted



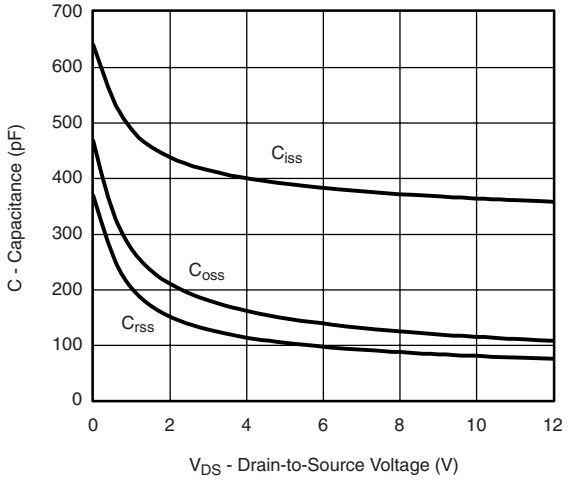
Output Characteristics



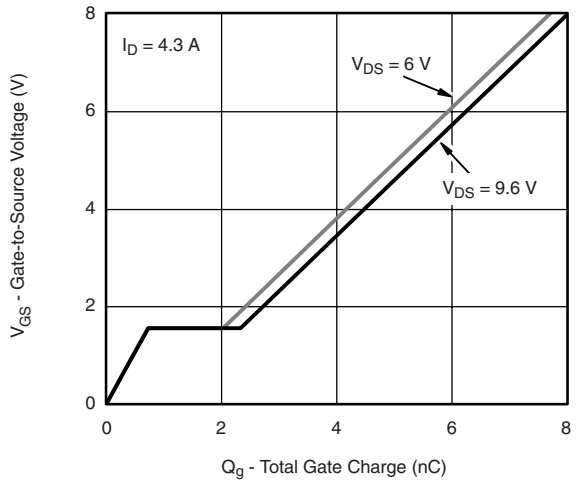
Transfer Characteristics



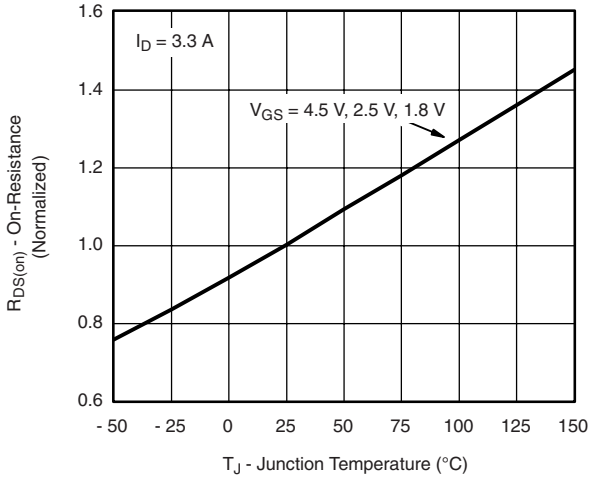
On-Resistance vs. Drain Current and Gate Voltage



Capacitance

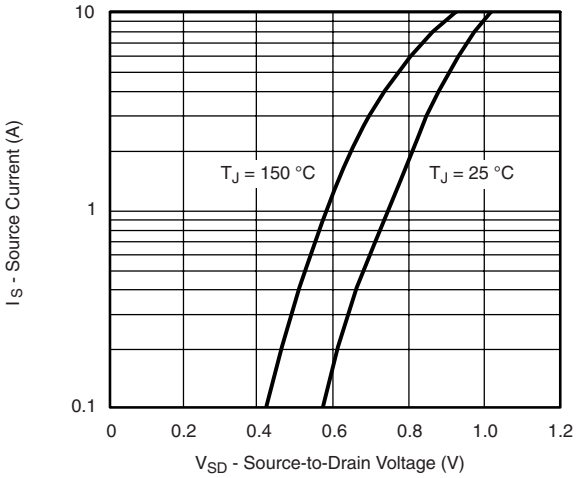


Gate Charge

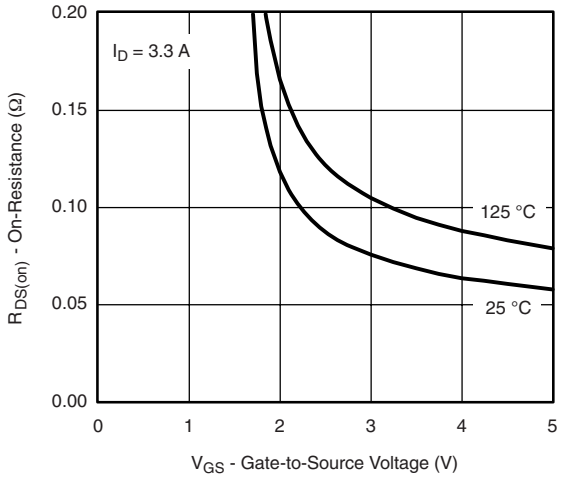


On-Resistance vs. Junction Temperature

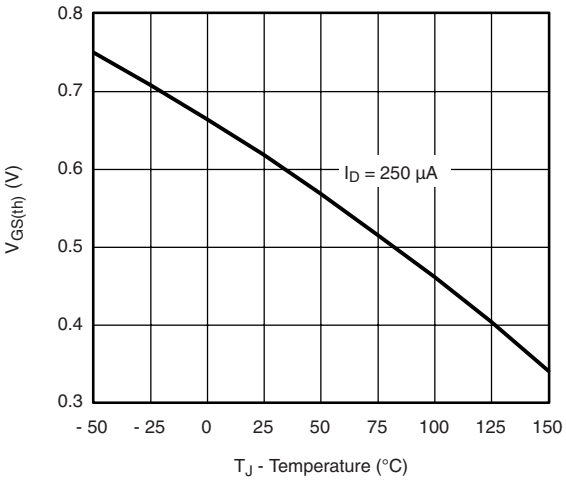
P-CHANNEL TYPICAL CHARACTERISTICS T_A = 25 °C, unless otherwise noted



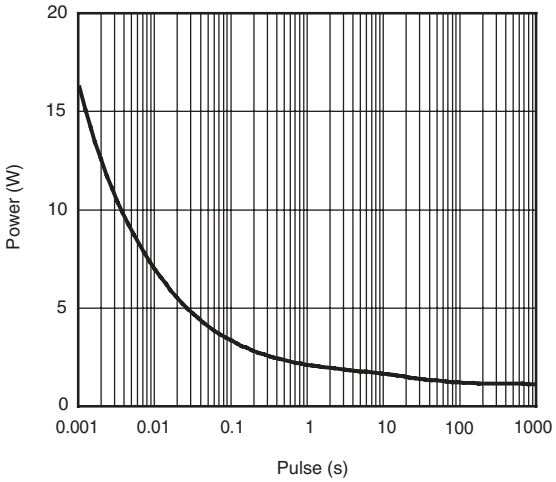
Soure-Drain Diode Forward Voltage



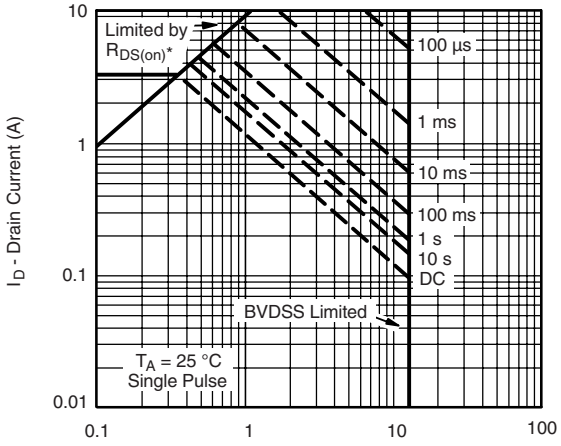
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient



* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Ambient

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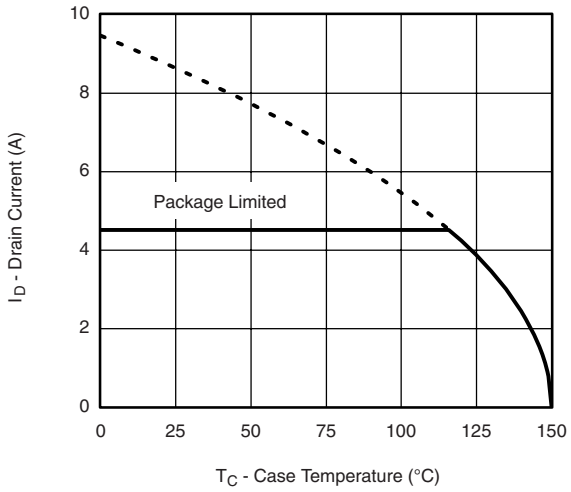
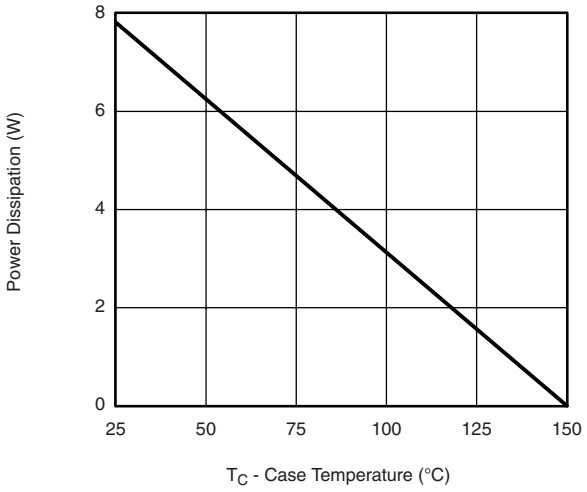
Vishay Siliconix

P-CHANNEL TYPICAL CHARACTERISTICS T_A = 25 °C, unless otherwise noted



Current Derating*

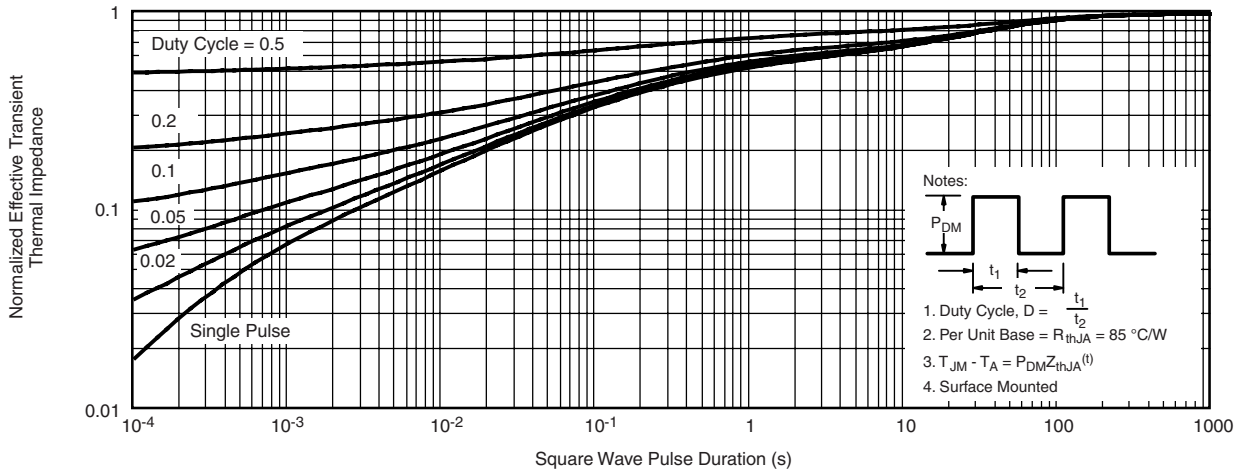


Power Derating

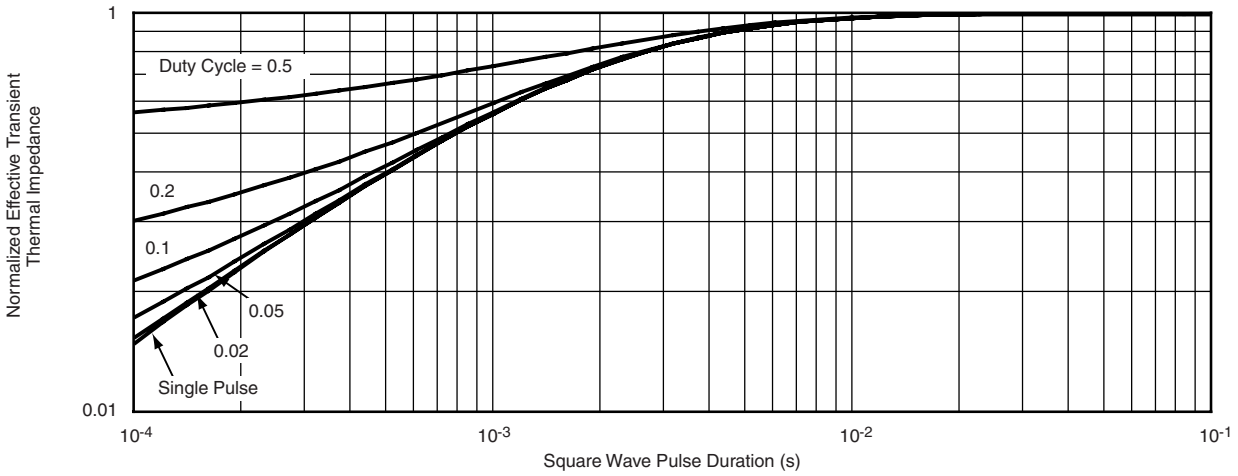
* The power dissipation P_D is based on $T_{J(max.)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

New Product

P-CHANNEL TYPICAL CHARACTERISTICS T_A = 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



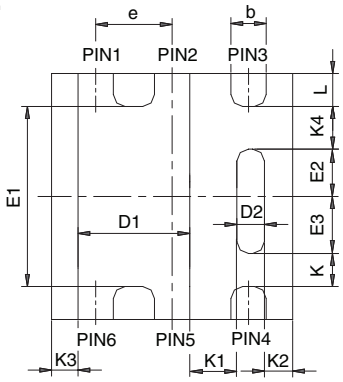
Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?65281.

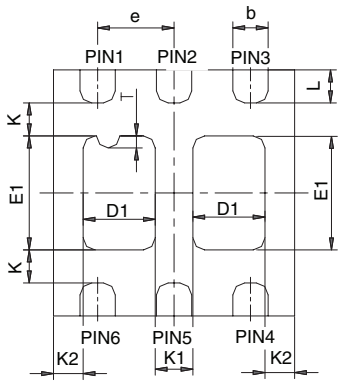
Package Information

Vishay Siliconix

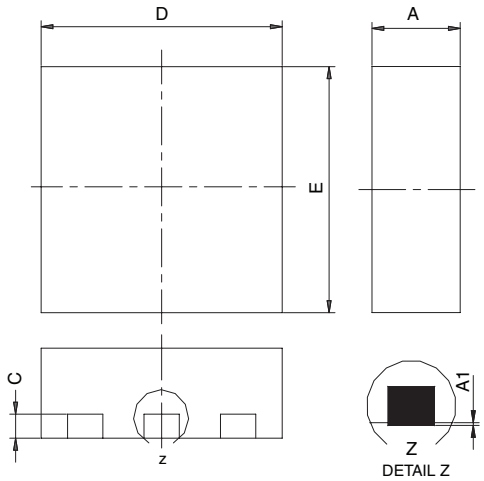
PowerPAK® SC70-6L



BACKSIDE VIEW OF SINGLE



BACKSIDE VIEW OF DUAL



DETAIL Z

Notes:
1. All dimensions are in millimeters
2. Package outline exclusive of mold flash and metal burr
3. Package outline inclusive of plating

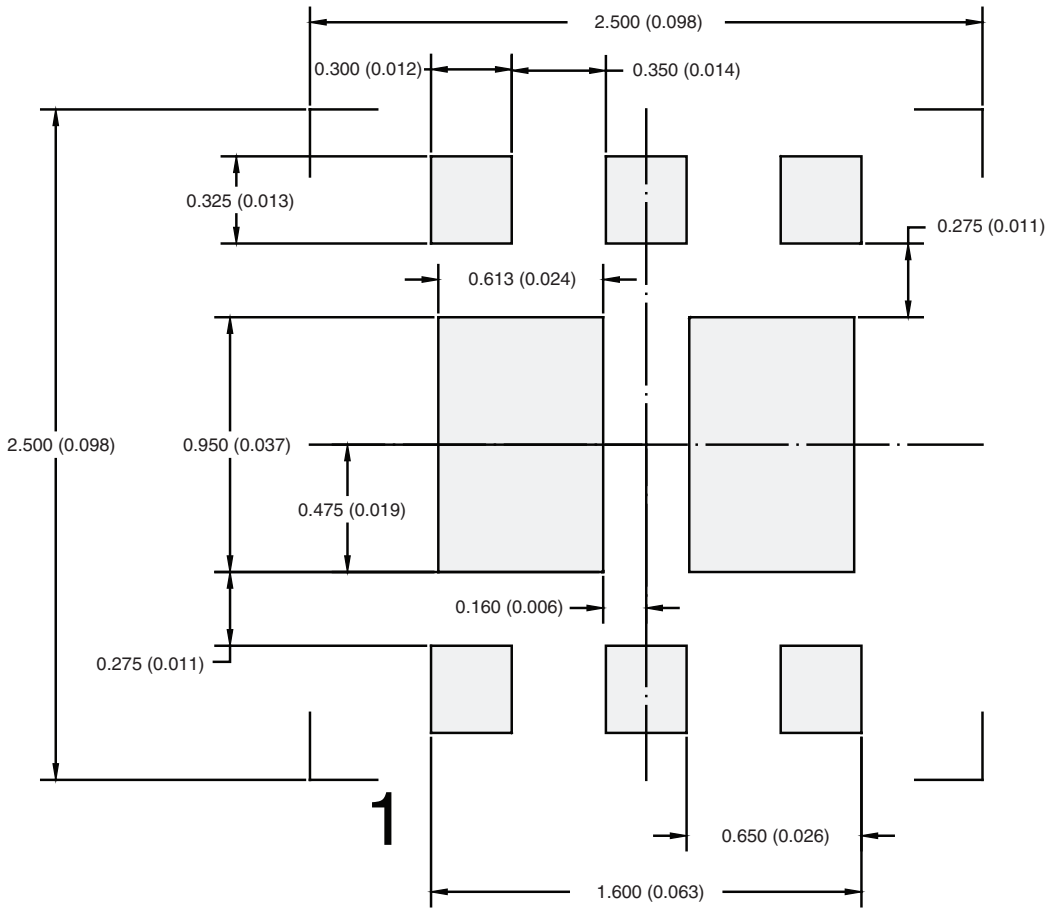
DIM	SINGLE PAD						DUAL PAD					
	MILLIMETERS			INCHES			MILLIMETERS			INCHES		
	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max
A	0.675	0.75	0.80	0.027	0.030	0.032	0.675	0.75	0.80	0.027	0.030	0.032
A1	0	-	0.05	0	-	0.002	0	-	0.05	0	-	0.002
b	0.23	0.30	0.38	0.009	0.012	0.015	0.23	0.30	0.38	0.009	0.012	0.015
C	0.15	0.20	0.25	0.006	0.008	0.010	0.15	0.20	0.25	0.006	0.008	0.010
D	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085
D1	0.85	0.95	1.05	0.033	0.037	0.041	0.513	0.613	0.713	0.020	0.024	0.028
D2	0.135	0.235	0.335	0.005	0.009	0.013						
E	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085
E1	1.40	1.50	1.60	0.055	0.059	0.063	0.85	0.95	1.05	0.033	0.037	0.041
E2	0.345	0.395	0.445	0.014	0.016	0.018						
E3	0.425	0.475	0.525	0.017	0.019	0.021						
e	0.65 BSC			0.026 BSC			0.65 BSC			0.026 BSC		
K	0.275 TYP			0.011 TYP			0.275 TYP			0.011 TYP		
K1	0.400 TYP			0.016 TYP			0.320 TYP			0.013 TYP		
K2	0.240 TYP			0.009 TYP			0.252 TYP			0.010 TYP		
K3	0.225 TYP			0.009 TYP								
K4	0.355 TYP			0.014 TYP								
L	0.175	0.275	0.375	0.007	0.011	0.015	0.175	0.275	0.375	0.007	0.011	0.015
T							0.05	0.10	0.15	0.002	0.004	0.006

ECN: C-07431 – Rev. C, 06-Aug-07
DWG: 5934

Application Note 826

Vishay Siliconix

RECOMMENDED PAD LAYOUT FOR PowerPAK® SC70-6L Dual



Dimensions in mm (inches)

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